

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	80	Vdc
Emitter-Base Voltage	V _{EBO}	4.0	Vdc
Collector Current — Continuous	I _C	100	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	Watt mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R _{θJA} (1)	200	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	83.3	°C/W

(1) R_{θJA} is measured with the device soldered into a typical printed circuit board.

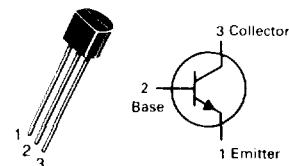
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage(2) (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	80	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 100 μAdc, I _E = 0)	V _{(BR)CBO}	80	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 100 μAdc, I _C = 0)	V _{(BR)EBO}	4.0	—	—	Vdc
Collector Cutoff Current (V _{CB} = 60 Vdc, I _E = 0)	I _{CBO}	—	—	50	nAdc
Emitter Cutoff Current (V _{EB} = 3.0 Vdc, I _C = 0)	I _{EBO}	—	—	50	nAdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 1.5 mAdc, V _{CE} = 10 Vdc)	H _{FE}	30	—	120	—
Collector-Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc)	V _{CE(sat)}	—	—	0.25	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain — Bandwidth Product (I _C = 1.5 mAdc, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	80	—	—	MHz
Collector-Base Capacitance (V _{CB} = 10 Vdc, f = 1.0 MHz)	C _{cb}	—	—	1.6	pF
Output Admittance (I _C = 1.5 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{oe}	—	—	5.0	μmhos
Noise Figure (I _C = 1.5 mAdc, V _{CE} = 10 Vdc, R _S = 50 ohms, f = 1.0 MHz) MPSH04	NF	—	—	2.0	dB

(2) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

MPSH04

CASE 29-04, STYLE 1 TO-92 (TO-226AA)



AMPLIFIER TRANSISTOR

NPN SILICON